

	Title	Current OR
1	Component mounting apparatus and method	29/834
2	Apparatus and method for mounting components on substrate	29/834
3	Apparatus and method for mounting components on substrate	29/832
4	Method and device for mounting electronic component	29/833
5	Method and device for mounting electronic component	29/832
6	Method and device for adjusting nozzle height for recognition in surface mounter	29/833
7	Method for mounting component chips and an apparatus therefor	29/832
8	Method for mounting components and an apparatus therefor	29/833

	Current XRef	Retrieval Classif
1	29/740; 29/743; 29/833	29/743; 29/833; 29/834
2	29/740; 29/832	29/834
3	29/740; 29/741; 29/833	29/833
4	29/740; 29/743; 29/832; 29/834	29/743; 29/833; 29/834
5	29/700; 29/709; 29/720; 29/739; 29/740; 29/833; 29/834; 29/836	29/833; 29/834
6	29/712; 29/743; 29/834; 29/DIG.44; 356/614; 414/730; 414/737; 901/40; 901/46	29/712; 29/743; 29/833; 29/834; 29/DIG.44; 356/614; 414/730; 414/737; 901/40; 901/46
7	29/740; 29/759; 29/833	29/833
8	29/740; 29/759	29/833

East search
up date 4/24/04

L Number	Hits	Search Text	DB	Time stamp
1	119	mounting adj component near method and 29/\$.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 07:50
2	0	mounting adj component near method and 29/\$.cccls. and classify near groups	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 07:51
3	0	mounting adj component near method and 29/\$.cccls. and classify	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 07:51
4	119	mounting adj component near method and 29/\$.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 07:52
5	87	mounting adj component near method and (29/740; 29/739 ; 29/720 ; 29/721 ; 29/830 ; 29/831 ; 29/832 ; 29/833 ; 29/834 ; 29/593 ; 29/898.07 ; 29/451.1 ; 29/407.4 ; 29/407.5 ; 29/407.9 ; 29/836 ; 29/743 ; 29/430 ; 29/825 ; 29/592 ; 29/702 ; 29/703 ; 29/592.1 ; 29/771 ; 29/709 ; 29/406 ; 29/700 ; 29/783).cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 07:54
6	77	mounting adj component near method and (29/743; 29/740 ; 29/739 ; 29/759 ; 29/721 ; 29/33M ; 29/742 ; 29/832 ; 29/834 ; 29/DIG.44 ; 294/2 ; 294/64.1 ; 901/40 ; 414/225 ; 414/737).cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 07:59
7	48	mounting adj component near method and (29/743; 29/740 ; 29/739 ; 29/759 ; 29/721 ; 29/33M ; 29/742 ; 29/832 ; 29/834 ; 29/DIG.44 ; 294/2 ; 294/64.1 ; 901/40 ; 414/225 ; 414/737).cccls. and nozzles	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 07:59
8	12	mounting adj component near method and (29/743; 29/740 ; 29/739 ; 29/759 ; 29/721 ; 29/33M ; 29/742 ; 29/832 ; 29/834 ; 29/DIG.44 ; 294/2 ; 294/64.1 ; 901/40 ; 414/225 ; 414/737).cccls. and nozzles and groups	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 08:01

9	8	mounting adj component near method and (29/833, 29/712 , 29/743 , 29/834 , 29/DIG.44 , 356/614	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 08:02
10	26	, 414/730 , 414/737 , 901/40 , 901/46).ccls. and nozzles and groups Takeyuki near Kawase.inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/24 08:02